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SERIAL NUMBER 10/681,747	FILING DATE 10/08/2003  RULE	CLASS 257	GROUP ART UNIT 2822	ATTORNEY DOCKET NO. CPAC 1029-6
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## APPLICANTS

Marcos Karnezos, Palo Alto, CA;

## \*\* CONTINUING DATA \*\*\*\*\*

This appln claims benefit of 60/417,277 10/08/2002  
 and claims benefit of 60/460,541 04/04/2003  
 and is a CIP of 10/618,933 07/14/2003  
 which claims benefit of 60/460,541 04/04/2003

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 01/05/2004

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY CA	SHEETS DRAWING 20	TOTAL CLAIMS 42	INDEPENDENT CLAIMS 2
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged	Examiner's Signature <i>[Signature]</i>	Initials		

## ADDRESS

22470  
 HAYNES BEFFEL & WOLFELD LLP  
 P O BOX 366  
 HALF MOON BAY , CA  
 94019

## TITLE

Semiconductor multi-package module having inverted second package stacked over die-up flip-chip ball grid array (BGA) package

FILING FEE  RECEIVED 1296	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____
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